

RoHS Compliant Product
 A suffix of "-C" specifies halogen & lead-free

FEATURES

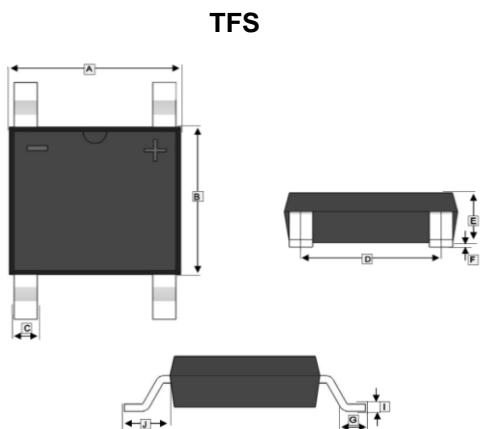
- Glass Passivated Chip Junction
- High Surge Current Capability

MECHANICAL DATA

- Terminals: Solderable per MIL-STD-750, Method 2026
- Case: TFS
- Mounting Position: Any

MARKING

Part Number	Marking	Part Number	Marking
TB24S	TB24S	TB210S	TB210S
TB26S	TB26S	TB220S	TB220S
TB28S	TB28S		



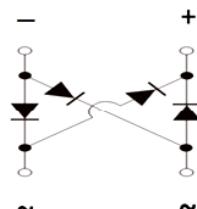
REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.9	5.2	F	0.2	TYP.
B	4.2	4.5	G	0.1	TYP.
C	0.5	0.7	H	6.0	6.4
D	3.8	4.2	I	0.15	0.22
E	1.3	1.5	J	0.95	TYP.

PACKAGE INFORMATION

Package	MPQ	Leader Size
TFS	5K	13 inch

ORDER INFORMATION

Part Number	Type
TB24S~TB220S	Lead (Pb)-free
TB24S-C~TB220S-C	Lead (Pb)-free and Halogen-free



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
 For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number					Unit
		TB24S	TB26S	TB28S	TB210S	TB220S	
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	40	60	80	100	200	V
Maximum RMS Voltage	V _{RMS}	28	42	56	70	140	V
Maximum DC Blocking Voltage	V _{DC}	40	60	80	100	200	V
Maximum Average Forward Current	I _{F(AV)}	2					A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	50		40			A
Maximum instantaneous forward voltage @ I _F =2A	V _F	0.55	0.70	0.85			V
Maximum DC Reverse Current at T _A =25°C Rated DC Blocking Voltage	I _R	0.5			0.3		mA
		10			5		
Typical Junction Capacitance ¹	C _J	220	80				pF
Thermal Resistance Junction to Ambient ²	R _{θJA}	70				°C/W	
Thermal Resistance Junction to Case ²	R _{θJC}	16					
Operating and Storage Temperature range	T _J , T _{STG}	125, -55~150				°C	

Note:

1. Measured at 1MHz and applied reverse voltage of 4 V D.C.
2. Mounted on glass epoxy PC board with 1.5mm² copper pad.

RATINGS AND CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

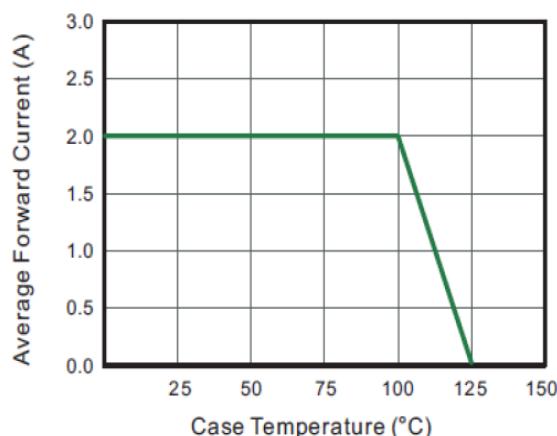


Fig.2 Typical Reverse Characteristics

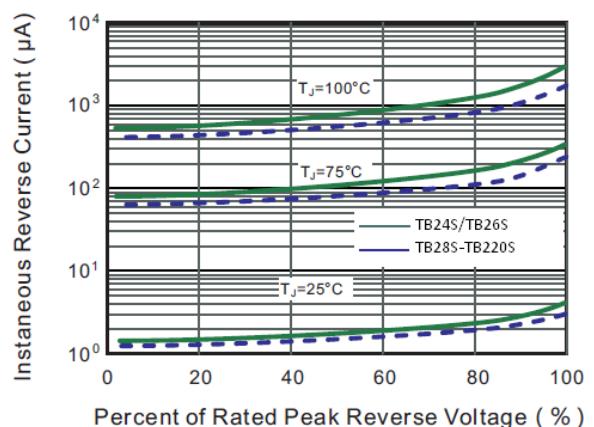


Fig.3 Typical Forward Characteristic

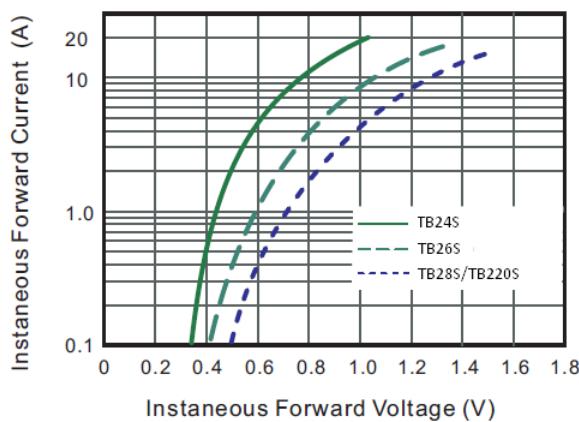


Fig.4 Typical Junction Capacitance

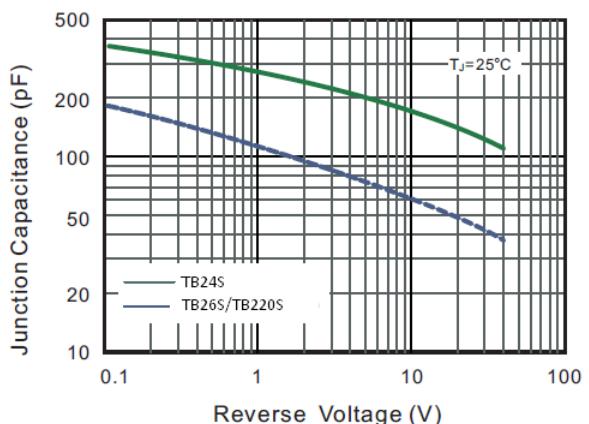


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

